

# APPLIED NOKOTA™ ECD

The Industry's Best Value in Wafer-Level Packaging

4 Key Features	5 Value Elements				
	On-Wafer Performance	Reliability	Wafer Protection	Extendibility	Productivity
SafeSeal™		✓	✓	✓	✓
HotSwap™		✓			✓
Engineered Modular Design		✓		✓	✓
VMax™ Chamber	✓				✓

## Saves Wafers, Time, Money

>350

Hours MTBF

>330

Hours More Availability  
Per Year

85,500-124,000

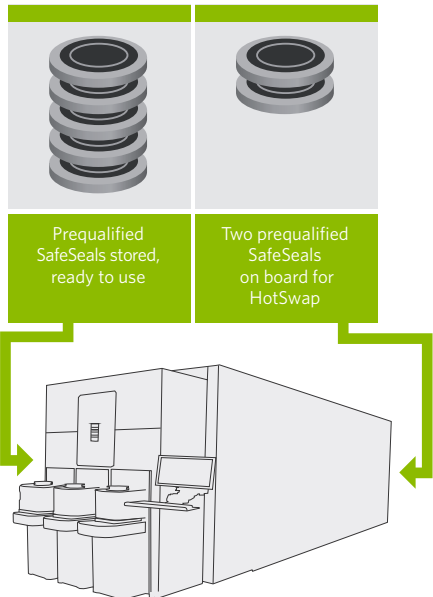
More Wafers Per Year

20%

Lower Capital Cost Per Wafer

Note: Bump /pillar process

## 40% Higher Productivity



Zero Tool Downtime for Seal Maintenance

>\$2.8M More Revenue Per Year, Per System

@ \$500/Wafer Pass